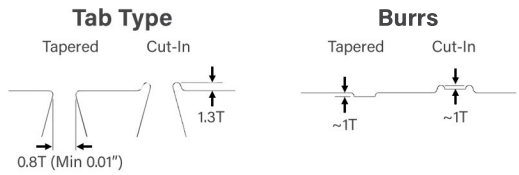
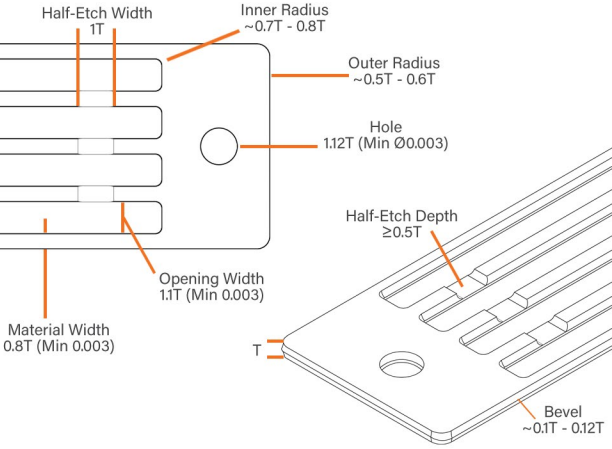




GENERAL ETCHING GUIDELINES

Photochemical Machining (PCM), or photo etching, is a manufacturing process using chemicals to remove defined areas of masked sheet metal, resulting in a precise part. This process is not as harsh as other processes (laser and stamping) and does not alter the molecular composition of the metal.



GENERAL TOLERANCES

- ± 0.001" (Thickness: 0.001" - 0.01")
- ± 0.002" (Thickness: >0.01" - ≤0.02")
- ± 0.003" (Thickness: >0.02" - <0.031")
- Minimum ± 0.004" (Thickness: ≥:0.031")

**Submit application drawing for review if tolerance requirement <±0.001"*

ADVANTAGES OF PCM

- LOWER COSTS
- FASTER TURNAROUND
- BROADER PRODUCTION VERSATILITY
- HIGHER QUALITY SURFACE FINISHES

PRODUCTS ETCHED BY E-FAB

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